

# SAW Components

Data Sheet B3770





#### **SAW Components**

Passivation layer: Elpas

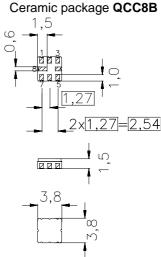
**Low-loss Filter** 

#### **Data Sheet**

Features

(SMT)

B3770 426,075 MHz



Terminals

Ni, gold plated

typ. dimensions in mm, approx. weight 0,07 g

## Pin configuration<sup>1)</sup>

1 Input Ground (recommended) or Input

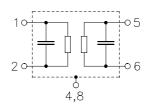
RF low-loss filter for remote control receivers

Balanced and unbalanced operation possible

AEC-Q200 qualified component family

■ Package for Surface Mounted Technology

- 2 Input (recommended) or Input Ground
- 5 Output (recommended) or Output Ground
- 6 Output Ground (recommended) or Output
- 4,8 Case Ground
- 3,7 to be grounded



Туре	Ordering code	Marking and package according to	Packing according to		
B3770	B39431-B3770-Z810	C61157-A7-A46	F61074-V8167-Z000		

Electrostactic Sensitive Device (ESD)

## **Maximum ratings**

Operable temperature range	T <sub>A</sub>	-45/+120	°C	
Storage temperature range	T <sub>stg</sub>	-45/+120	°C	
DC voltage	V <sub>DC</sub>	6	V	
Source power	$P_S$	10	dBm	source impedance 50 $\Omega$

<sup>1)</sup> The recommended pin configuration usually offers best suppression of electrical crosstalk. The filter characteristics refer to this configuration.

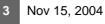




Low-loss Filter			426,075 MHz		
Data Sheet					
Characteristics					
Terminating source impedance: Z <sub>S</sub>	= 50 Ω		ning network ning network		
		min.	typ.	max.	
Center frequency	f <sub>C</sub>		426,075		MHz
(center frequency between 3 dB points)					
Minimum insertion attenuation	$lpha_{min}$				
including loss in matching elements		_	1,9	3,0	dB
excluding loss in matching elements			1,6	2,7	dB
Pass band (relative to $\alpha_{min}$ )					
426,00 426,15 MHz			0,5	2,0	dB
425,98 426,17 MHz			0,7	3,0	dB
425,94 426,21 MHz			1,0	6,0	dB
Filter bandwidth					
$\alpha_{rel} \leq 3 dB$		0,62	0,68	0,74	MHz
Relative attenuation (relative to $\alpha_{min}$ )	$\alpha_{\text{rel}}$				
10,00 406,00 MHz		52	56		dB
406,00 415,66 MHz		48	52		dB
415,66 423,88 MHz		27	32		dB
423,88 424,28 MHz		26	35	_	dB
424,28 425,26 MHz		17	21	_	dB
427,07 434,00 MHz		17	20		dB
434,00 500,00 MHz		38	43	_	dB
500,00 690,00 MHz		50	55	_	dB
690,00 790,00 MHz		45	50	_	dB
790,001000,00 MHz		60	65		dB
1000,002500,00 MHz		55	60	_	dB
Impedance for pass band matching 1)					
Input: $Z_{IN} = R_{IN} \parallel C_{IN}$		—	250    2,4	—	$\Omega \parallel pl$
Output: $Z_{OUT} = R_{OUT}    C_{OUT}$			250    2,4		Ω    pF

<sup>1)</sup> Impedance for passband matching bases on an ideal, perfect matching of the SAW filter to source- and to load impedance (here 50 Ohm). After the SAW filter is removed and input impedance into the input matching / output matching network is calculated.

The conjugate complex value of these characteristic impedances are the input and output impedances for flat passband. For more details, we refer to EPCOS application note #4.

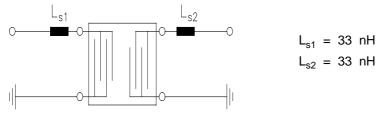




# Low-loss Filter

Data Sheet

Matching network to 50  $\Omega$  (element values depend on pcb layout and equivalent circuit)



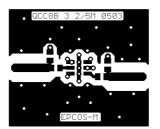
Minimising the crosstalk

For a good ultimate rejection a low crosstalk is necessary. Low crosstalk can be realised with a good RF layout. The major crosstalk mechanism is caused by the "ground-loop" problem.

Grounding loops are created if input-and output transducer GND are connected on the top-side of the PCB and fed to the system grounding plane by a common via hole. To avoid the common ground path, the ground pin of the input- and output transducer are fed to the system ground plane (bottom PCB plane) by their own via hole. The transducers' grounding pins should be isolated from the upper grounding plane.

A common GND inductivity of 0.5nH degrades the ultimate rejection (crosstalk) by 20dB.

The optimised PCB layout, including matching network for transformation to 50 Ohm, is shown here. In this PCB layout the grounding loops are minimised to realise good ultimate rejection.



Optimised PCB layout for SAW filters in QCC8B package, pinning 2,5 (top side, scale 1:1)

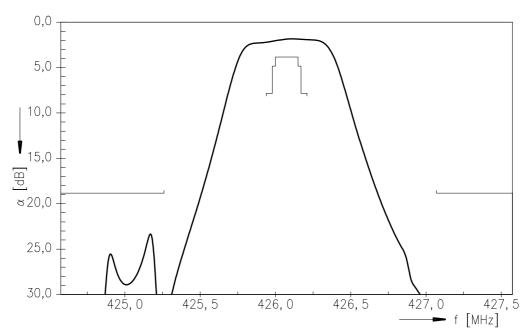
The bottom side is a copper plane (system ground area). The input and output grounding pins are isolated and connected to the common ground by separated via holes.

For good contact of the upper grounding area with the lower side it is necessary to place enough via holes.

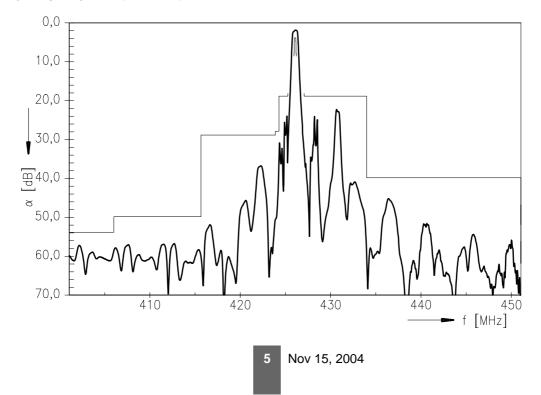


**Data Sheet** 

# **Frequency response**



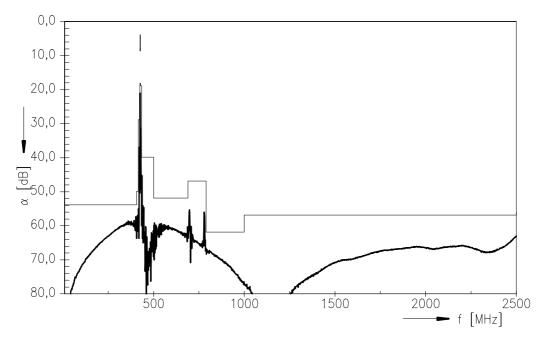
# Frequency response (wideband)





Data Sheet

#### Frequency response (ultimate rejection)



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